Surface Mount Schottky Power Rectifier

SMB Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop

Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Maximum Temperature of 260°C/10 Seconds for Soldering
- Available in 12 mm Tape, 2500 Units per 13" Reel, Add "T3" Suffix to Part Number
- Cathode Polarity Band
- Marking: 2BL3

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
Average Rectified Forward Current (At Rated V _R , T _C = 110°C)		2.0	Α
Peak Repetitive Forward Current (At Rated V_R , Square Wave, 20 kHz, $T_C = 105^{\circ}C$)	I _{FRM}	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions, Halfwave, Single Phase, 60 Hz)	I _{FSM}	40	Α
Storage/Operating Case Temperature	T _{stg} , T _C	-55 to +175	°C
Operating Junction Temperature	T _J	-55 to +125	°C
Voltage Rate of Change (Rated V _R , T _J = 25°C)	dv/dt	10,000	V/μs



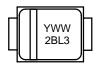
http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES 30 VOLTS



SMB CASE 403A PLASTIC

MARKING DIAGRAM



Y = Year WW= Work Week 2BL3 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
MBRS230LT3	SMB	2500/Tape & Reel

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction-to-Lead (Note 1)	$R_{ heta JL}$	18.6	°C/W
Thermal Resistance - Junction-to-Ambient (Note 1)	$R_{\theta JA}$	135	

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2)	V _F	T _J = 25°C	T _J = 125°C	Volts
see Figure 2 $(I_F = 2.0 \text{ A})$		0.50 0.60	0.45 0.63	
Maximum Instantaneous Reverse Current (Note 2)	I _R	T _J = 25°C	T _J = 125°C	mA
see Figure 4 $(V_R = 30 \text{ V})$		1 0.31	75 35	

- Minimum pad size (0.108" X 0.085") for each lead on FR4 board.
 Pulse Test: Pulse Width ≤ 250 μs, Duty Cycle ≤ 2.0%.

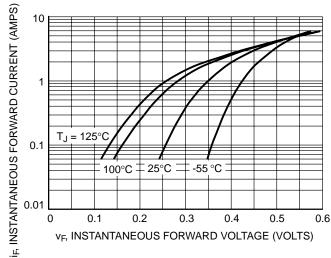


Figure 1. Typical Forward Voltage

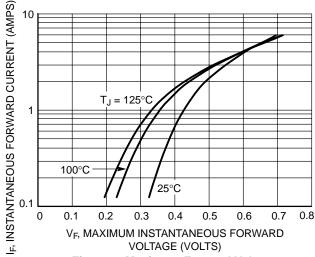


Figure 2. Maximum Forward Voltage

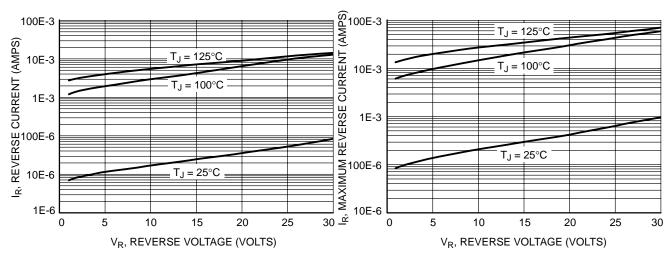
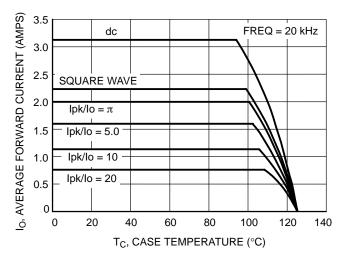


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current



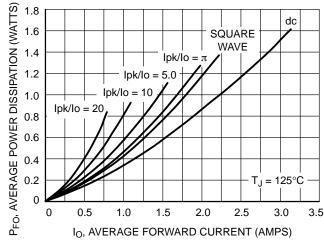


Figure 5. Current Derating Per Leg

Figure 6. Forward Power Dissipation Per Leg

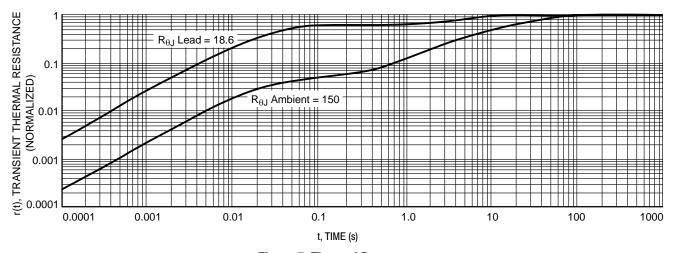
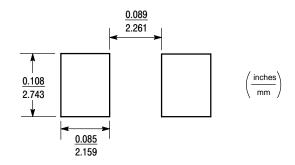


Figure 7. Thermal Response

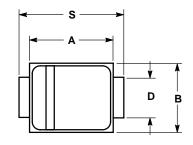
MINIMUM SOLDER PAD SIZES

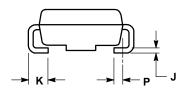


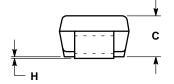
PACKAGE DIMENSIONS

SMB

PLASTIC PACKAGE CASE 403A-03 ISSUE D







- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.160	0.180	4.06	4.57	
В	0.130	0.150	3.30	3.81	
С	0.075	0.095	1.90	2.41	
D	0.077	0.083	1.96	2.11	
Н	0.0020	0.0060	0.051	0.152	
J	0.006	0.012	0.15	0.30	
K	0.030	0.050	0.76	1.27	
P	0.020 REF		0.51 REF		
S	0.205	0.220	5.21	5.59	

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